# Product Change Notice

**Exar Corporation**  
www.exar.com  |  Support: customersupport@exar.com  

**PCN Number:** 15-0520-01  
**Issue Date:** 27-AUGUST-2015

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**PRODUCTS AFFECTED:**  
| SP3070EMN-L | SP3070EMN-L/TR  
| SP3071EMN-L | SP3071EMN-L/TR  
| SP3072EMN-L | SP3072EMN-L/TR  
| SP3073EMN-L | SP3073EMN-L/TR  
| SP3074EMN-L | SP3074EMN-L/TR  
| SP3075EMN-L | SP3075EMN-L/TR  
| SP3076EMN-L | SP3076EMN-L/TR  
| SP3077EMN-L | SP3077EMN-L/TR  
| SP3078EMN-L | SP3078EMN-L/TR  

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**CHANGE CATEGORY:**  
- [ ] Material  
- [ ] Design  
- [ ] Process  
- [ ] Package  
- [ ] Datasheet  
- [ ] Packing/Shipping  
- [x] Other: Alternate Foundry and Assembly/Test Site

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**DESCRIPTION OF CHANGE:**  
Qualification of 0.25um CMOS process at TSMC.  
Qualification of alternate assembly sites, Carsem (for 8 and 14L nSOIC) and ASE Chung-Li (for 8L nSOIC).

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**IMPACT OF CHANGE:**  
No change to product form, fit or function.

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**TARGET IMPLEMENTATION DATE:** 27-NOVEMBER-2015

Please contact customer support (customersupport@exar.com) for sample date availability or qualification data.

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